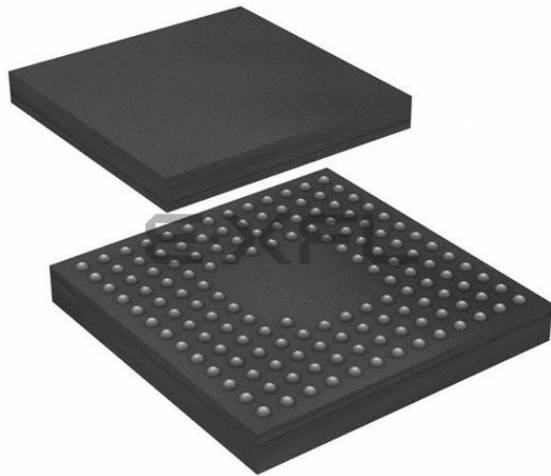




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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I ² C, IrDA, MMC/SD, QSPI, SCI, SPI, SSI, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	110
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	640K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 22x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	145-TFLGA
Supplier Device Package	145-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r7fs5d97e2a01clk-ac0

Leading performance 120-MHz ARM Cortex-M4 microcontroller, up to 2-MB code flash memory, 640-KB SRAM, Graphics LCD Controller, 2D Drawing Engine, Capacitive Touch Sensing Unit, Ethernet MAC Controller with IEEE 1588 PTP, USB 2.0 High-Speed, USB 2.0 Full-Speed, SDHI, Quad SPI, security and safety features, and advanced analog.

Features

■ ARM Cortex-M4 Core with Floating Point Unit (FPU)

- ARMv7E-M architecture with DSP instruction set
- Maximum operating frequency: 120 MHz
- Support for 4-GB address space
- On-chip debugging system: JTAG, SWD, and ETM
- Boundary scan and ARM Memory Protection Unit (MPU)

■ Memory

- Up to 2-MB code flash memory (40 MHz zero wait states)
- 64-KB data flash memory (up to 100,000 erase/write cycles)
- Up to 640-KB SRAM
- Flash Cache (FCACHE)
- Memory Protection Units (MPU)
- Memory Mirror Function (MMF)
- 128-bit unique ID

■ Connectivity

- Ethernet MAC Controller (ETHERC)
- Ethernet DMA Controller (EDMAC)
- Ethernet PTP Controller (EPTPC)
- USB 2.0 High-Speed Module (USBHS)
 - On-chip transceiver
 - USB battery charge version 1.2 supported
- USB 2.0 Full-Speed Module (USBFS)
 - On-chip transceiver
- Serial Communications Interface (SCI) with FIFO × 10
- Serial Peripheral Interface (SPI) × 2
- I²C Bus Interface (IIC) × 3
- CAN module (CAN) × 2
- Serial Sound Interface Enhanced (SSIE) × 2
- SD/MMC Host Interface (SDHI) × 2
- Quad Serial Peripheral Interface (QSPI)
- IrDA interface
- Sampling Rate Converter (SRC)
- External address space
 - 8- or 16-bit bus space is selectable per area
 - SDRAM support

■ Analog

- 12-Bit A/D Converter (ADC12) with 3 sample-and-hold circuits each × 2
- 12-Bit D/A Converter (DAC12) × 2
- High-Speed Analog Comparator (ACMPHS) × 6
- Programmable Gain Amplifier (PGA) × 6
- Temperature sensor (TSN)

■ Timers

- General PWM Timer 32-Bit Enhanced High Resolution (GPT32EH) × 4
- General PWM Timer 32-Bit Enhanced (GPT32E) × 4
- General PWM Timer 32-Bit (GPT32) × 6
- Asynchronous General-Purpose Timer (AGT) × 2
- Watchdog Timer (WDT)

■ Safety

- ECC in SRAM
- SRAM parity error check
- Flash area protection
- ADC self-diagnosis function
- Clock Frequency Accuracy Measurement Circuit (CAC)
- Cyclic Redundancy Check (CRC) calculator
- Data Operation Circuit (DOC)
- Port Output Enable for GPT (POEG)
- Independent Watchdog Timer (IWDT)
- GPIO readback level detection
- Register write protection
- Main oscillator stop detection
- Illegal memory access

■ System and Power Management

- Low-power modes
- Realtime Clock (RTC) with calendar and VBATT support
- Event Link Controller (ELC)
- DMA Controller (DMAC) × 8
- Data Transfer Controller (DTC)
- Key interrupt function (KINT)
- Power-on reset
- Low Voltage Detection (LVD) with voltage settings

■ Security and Encryption

- AES128/192/256
- 3DES/ARC4
- SHA1/SHA224/SHA256
- GHASH
- RSA/DSA
- True Random Number Generator (TRNG)

■ Human Machine Interface (HMI)

- Graphics LCD Controller (GLCDC)
- JPEG Codec
- 2D Drawing Engine (DRW)
- Capacitive Touch Sensing Unit (CTSU)
- Parallel Data Capture Unit (PDC)

■ Multiple Clock Sources

- Main clock oscillator (MOSC) (8 to 24 MHz)
- Sub-clock oscillator (SOSC) (32.768 kHz)
- High-speed on-chip oscillator (HOCO) (16/18/20 MHz)
- Middle-speed on-chip oscillator (MOCO) (8 MHz)
- Low-speed on-chip oscillator (LOCO) (32.768 kHz)
- Independent Watchdog Timer OCO (15 kHz)
- Clock trim function for HOCO/MOCO/LOCO
- Clock out support

■ General-Purpose I/O Ports

- Up to 133 input/output pins
 - Up to 9 CMOS input
 - Up to 124 CMOS input/output
 - Up to 21 5-V tolerant input/output
 - Up to 18 high current (20 mA)

■ Operating Voltage

- VCC: 2.7 to 3.6 V

■ Operating Temperature and Packages

- Ta = -40°C to +85°C
 - 176-pin BGA (13 mm × 13 mm, 0.8 mm pitch)
 - 145-pin LGA (7 mm × 7 mm, 0.5 mm pitch)
- Ta = -40°C to +105°C
 - 176-pin LQFP (24 mm × 24 mm, 0.5 mm pitch)
 - 144-pin LQFP (20 mm × 20 mm, 0.5 mm pitch)
 - 100-pin LQFP (14 mm × 14 mm, 0.5 mm pitch)

Table 1.3 System (3 of 3)

Feature	Functional description
Independent Watchdog Timer (IWDT)	The IWDT consists of a 14-bit down-counter that must be serviced periodically to prevent counter underflow. The IWDT provides functionality to reset the MCU or to generate a non-maskable interrupt or interrupt for a timer underflow. Because the timer operates with an independent, dedicated clock source, it is particularly useful in returning the MCU to a known state as a fail safe mechanism when the system runs out of control. The IWDT can be triggered automatically on a reset, underflow, or refresh error, or by a refresh of the count value in the registers. See section 28, Independent Watchdog Timer (IWDT) in User's Manual.

Table 1.4 Event link

Feature	Functional description
Event Link Controller (ELC)	The ELC uses the interrupt requests generated by various peripheral modules as event signals to connect them to different modules, enabling direct interaction between the modules without CPU intervention. See section 19, Event Link Controller (ELC) in User's Manual.

Table 1.5 Direct memory access

Feature	Functional description
Data Transfer Controller (DTC)	A DTC module is provided for transferring data when activated by an interrupt request. See section 18, Data Transfer Controller (DTC) in User's Manual.
DMA Controller (DMAC)	An 8-channel DMAC module is provided for transferring data without the CPU. When a DMA transfer request is generated, the DMAC transfers data stored at the transfer source address to the transfer destination address. See section 17, DMA Controller (DMAC) in User's Manual.

Table 1.6 External bus interface

Feature	Functional description
External buses	- CS area (EXBIU): Connected to the external devices (external memory interface) - SDRAM area (EXBIU): Connected to the SDRAM (external memory interface) - QSPI area (EXBIUT2): Connected to the QSPI (external device interface).

Table 1.7 Timers

Feature	Functional description
General PWM Timer (GPT)	The GPT is a 32-bit timer with 14 channels. PWM waveforms can be generated by controlling the up-counter, down-counter, or up- and down-counter. In addition, PWM waveforms can be generated for controlling brushless DC motors. The GPT can also be used as a general-purpose timer. See section 23, General PWM Timer (GPT) in User's Manual.
Port Output Enable for GPT (POEG)	Use the Port Output Enable for GPT (POEG) function to place the General PWM Timer (GPT) output pins in the output disable state. See section 22, Port Output Enable for GPT (POEG) in User's Manual.
Asynchronous General-Purpose Timer (AGT)	The AGT is a 16-bit timer that can be used for pulse output, external pulse width or period measurement, and counting of external events. This 16-bit timer consists of a reload register and a down-counter. The reload register and the down-counter are allocated to the same address, and can be accessed with the AGT register. See section 25, Asynchronous General-Purpose Timer (AGT) in User's Manual.
Realtime Clock (RTC)	The RTC has two counting modes, calendar count mode and binary count mode, that are controlled by the register settings. For calendar count mode, the RTC has a 100-year calendar from 2000 to 2099 and automatically adjusts dates for leap years. For binary count mode, the RTC counts seconds and retains the information as a serial value. Binary count mode can be used for calendars other than the Gregorian (Western) calendar. See section 26, Realtime Clock (RTC) in User's Manual.

Table 1.13 Security

Feature	Functional description
Secure Crypto Engine 7 (SCE7)	• Security algorithms: - Symmetric algorithms: AES, 3DES, and ARC4 - Asymmetric algorithms: RSA and DSA. • Other support features: - TRNG (True Random Number Generator) - Hash-value generation: SHA1, SHA224, SHA256, GHASH - 128-bit unique ID.

1.2 Block Diagram

[Figure 1.1](#) shows the block diagram of the MCU superset. Some individual devices within the group have a subset of the features.

1.3 Part Numbering

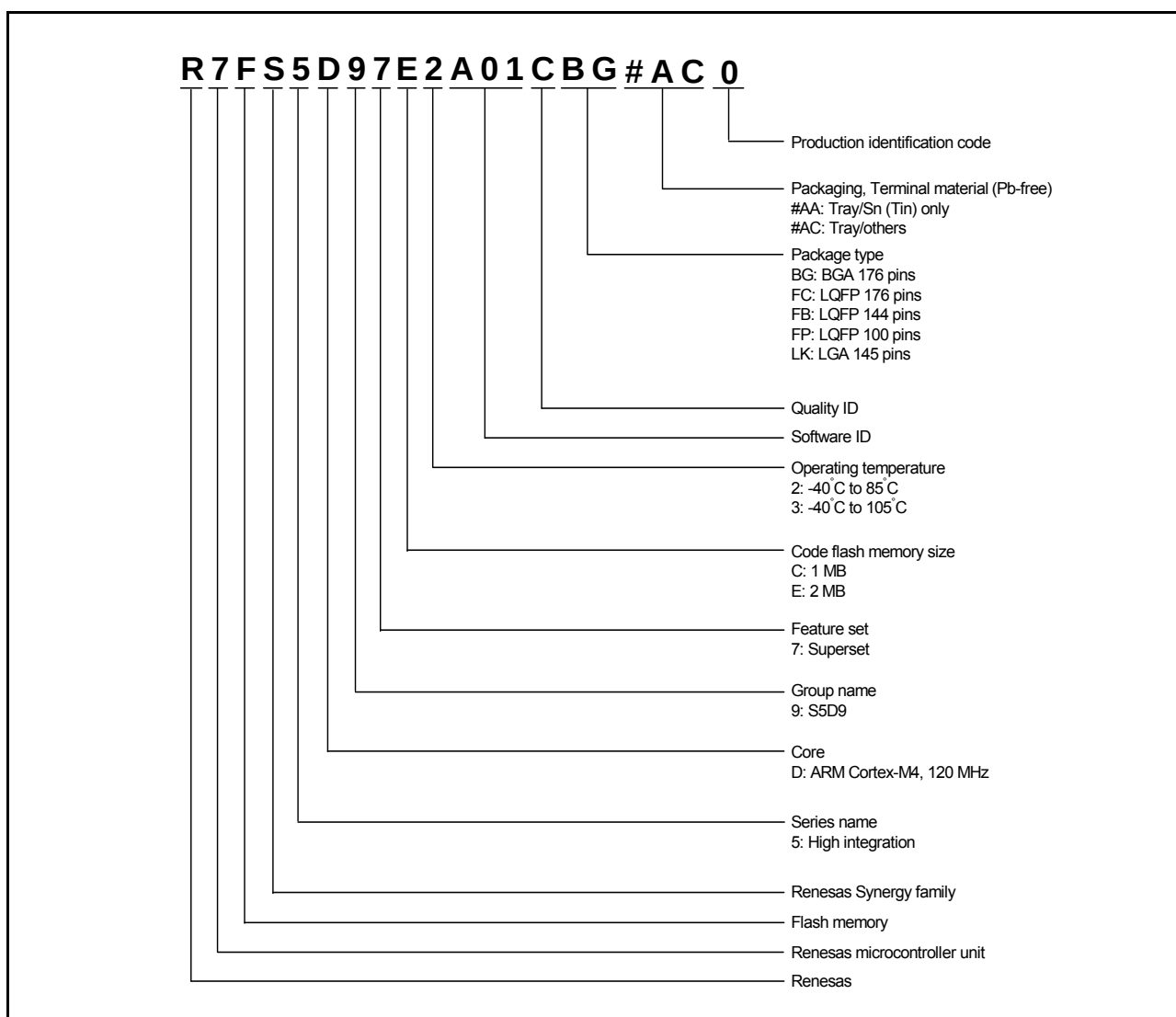


Figure 1.2 Part numbering scheme

Table 1.14 List of Products

Part Number	Orderable Part Number	Package	Code flash	Data flash	SRAM	Operating Temperature
R7FS5D97E2A01CBG	R7FS5D97E2A01CBG#AC0	PLBG0176GE-A	2 MB	64 KB	640 KB	-40 to +85°C
R7FS5D97E3A01CFC	R7FS5D97E3A01CFC#AA0	PLQP0176KB-A				-40 to +105°C
R7FS5D97E2A01CLK	R7FS5D97E2A01CLK#AC0	PTLG0145KA-A				-40 to +85°C
R7FS5D97E3A01CFB	R7FS5D97E3A01CFB#AA0	PLQP0144KA-B				-40 to +105°C
R7FS5D97E3A01CFP	R7FS5D97E3A01CFP#AA0	PLQP0100KB-B				-40 to +105°C
R7FS5D97C2A01CBG	R7FS5D97C2A01CBG#AC0	PLBG0176GE-A	1 MB			-40 to +85°C
R7FS5D97C3A01CFC	R7FS5D97C3A01CFC#AA0	PLQP0176KB-A				-40 to +105°C
R7FS5D97C2A01CLK	R7FS5D97C2A01CLK#AC0	PTLG0145KA-A				-40 to +85°C
R7FS5D97C3A01CFB	R7FS5D97C3A01CFB#AA0	PLQP0144KA-B				-40 to +105°C
R7FS5D97C3A01CFP	R7FS5D97C3A01CFP#AA0	PLQP0100KB-B				-40 to +105°C

Table 1.16 Pin functions (3 of 5)

Function	Signal	I/O	Description
SPI	RSPCKA, RSPCKB	I/O	Clock input/output pin.
	MOSIA, MOSIB	I/O	Input or output pins for data output from the master.
	MISOA, MISOB	I/O	Input or output pins for data output from the slave.
	SSLA0, SSLB0	I/O	Input or output pin for slave selection.
	SSLA1 to SSLA3, SSLB1 to SSLB3	Output	Output pins for slave selection.
QSPI	QSPCLK	Output	QSPI clock output pin.
	QSSL	Output	QSPI slave output pin.
	QIO0 to QIO3	I/O	Data0 to Data3.
CAN	CRX0, CRX1	Input	Receive data.
	CTX0, CTX1	Output	Transmit data.
USBFS	VCC_USB	Input	Power supply pins.
	VSS_USB	Input	Ground pins.
	USB_DP	I/O	D+ I/O pin of the USB on-chip transceiver. Connect this pin to the D+ pin of the USB bus.
	USB_DM	I/O	D- I/O pin of the USB on-chip transceiver. Connect this pin to the D- pin of the USB bus.
	USB_VBUS	Input	USB cable connection monitor pin. Connect this pin to VBUS of the USB bus. The VBUS pin status (connected or disconnected) can be detected when the USB module is operating as a function controller.
	USB_EXICEN	Output	Low-power control signal for external power supply (OTG) chip.
	USB_VBUSEN	Output	VBUS (5 V) supply enable signal for external power supply chip.
	USB_OVRCURA, USB_OVRCURB	Input	Connect the external overcurrent detection signals to these pins. Connect the VBUS comparator signals to these pins when the OTG power supply chip is connected.
	USB_ID	Input	Connect the MicroAB connector ID input signal to this pin during operation in OTG mode.
USBHS	VCC_USBHS	Input	Power supply pin.
	VSS1_USBHS	Input	Ground pin.
	VSS2_USBHS	Input	Ground pin.
	AVCC_USBHS	Input	Analog power supply pin for the USBHS.
	AVSS_USBHS	Input	Analog ground pin for the USBHS. Must be shorted to the PVSS_USBHS pin.
	PVSS_USBHS	Input	PLL circuit ground pin for the USBHS. Must be shorted to the AVSS_USBHS pin.
	USBHS_RREF	I/O	USBHS reference current source pin. Connect this pin to the AVSS_USBHS pin through a 2.2-kΩ resistor ($\pm 1\%$).
	USBHS_DP	I/O	USB bus D+ data pin.
	USBHS_DM	I/O	USB bus D- data pin.
	USBHS_EXICEN	Output	Connect this pin to the OTG power supply IC.
	USBHS_ID	Input	Connect this pin to the OTG power supply IC.
	USBHS_VBUSEN	Output	VBUS power enable signal for USB.
	USBHS_OVRCURA, USBHS_OVRCURB	Input	Overcurrent pin for USB.
	USBHS_VBUS	Input	USB cable connection monitor input pin.

Pin number					Power, System, Clock, Debug, CAC	Interrupt	I/O port	Extbus		Timers		Communication interfaces										Analog		HMI	
BGA176	LQFP176	LGA145	LQFP144	LQFP100				External bus	SDRAM	AGT	GPT	GPT	RTC	USBFS, CAN	SCIO.2,4,6,8 (30 MHz)	SCI1.3,5,7,9 (30 MHz)	IIC	SPI, QSPI	SSIE	ETHERC (MII) (25 MHz)	ETHERC (RMII) (50 MHz)	USBHS	SDHI	ADC12	DAC12, ACMPHS
A8	66	A6	54	37	TRDATA3	-	P208	-	-	-	GTOVLO	-	-	-	-	QIO3	-	ET0_LI NKSTA	ET0_LI NKSTA	SD0 DAT0_B	-	-	-	-	LCD_DATA 18_B
C9	67	C7	55	38	RES	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
B8	68	B6	56	39	MD	-	P201	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
C8	69	C8	57	40	-	NMI	P200	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
D8	70	-	-	-	-	-	P908	CS7	-	-	-	GTIOC 2A	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 14_B
D7	71	-	-	-	-	-	P907	CS6	-	-	-	GTIOC 2B	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 13_B
A7	72	-	-	-	-	-	P906	CS5	-	-	-	GTIOC 3A	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 12_B
B7	73	-	-	-	-	-	P905	CS4	-	-	-	GTIOC 3B	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 11_B
C7	74	C6	58	-	-	-	P312	CS3	CAS	AGTOA1	-	-	-	-	CTS3 RTS3/ SS3	-	-	-	-	-	-	-	-	-	-
D6	75	B5	59	-	-	-	P311	CS2	RAS	AGTOB1	-	-	-	-	SCK3	-	-	-	-	-	-	-	-	-	LCD_DATA 23_A
A6	76	D7	60	-	-	-	P310	A15	A15	AGTEE1	-	-	-	-	TXD3	-	QIO3	-	-	-	-	-	-	-	LCD_DATA 22_A
B6	77	A5	61	-	-	-	P309	A14	A14	-	-	-	-	-	RXD3	-	QIO2	-	-	-	-	-	-	-	LCD_DATA 21_A
A5	78	C5	62	-	-	-	P308	A13	A13	-	-	-	-	-	-	-	QIO1	-	-	-	-	-	-	-	LCD_DATA 20_A
C6	79	A4	63	41	-	-	P307	A12	A12	-	GTOUUP	-	-	CTS6	-	-	QIO0	-	-	-	-	-	-	-	LCD_DATA 19_A
A4	80	B4	64	42	-	-	P306	A11	A11	-	GTOULO	-	-	-	SCK6	-	QSSL	-	-	-	-	-	-	-	LCD_DATA 18_A
B5	81	D6	65	43	-	IRQ8	P305	A10	A10	-	GTOUUP	-	-	TXD6/ MOSI6 /SDA6	-	-	QSPC LK	-	-	-	-	-	-	-	LCD_DATA 17_A
B4	82	C4	66	44	-	IRQ9	P304	A09	A09	-	GTOULO	GTIOC 7A	-	-	RXD6/ MISO6 /SCL6	-	-	-	-	-	-	-	-	-	LCD_DATA 16_A
C5	83	A3	67	45	VSS	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
D5	84	B3	68	46	VCC	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
A3	85	D5	69	47	-	-	P303	A08	A08	-	-	GTIOC 7B	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 15_A
B3	86	A2	70	48	-	IRQ5	P302	A07	A07	-	GTOUUP	GTIOC 4A	-	TXD2/ MOSI2 /SDA2	-	-	SSLB3 _B	-	-	-	-	-	-	-	LCD_DATA 14_A
A2	87	C3	71	49	-	IRQ6	P301	A06	A06	AGTIO0	GTOULO	GTIOC 4B	-	RXD2/ MISO2 /SCL2	CTS9 RTS9/ SS9	-	SSLB2 _B	-	-	-	-	-	-	-	LCD_DATA 13_A
C4	88	B2	72	50	TCK/SW CLK	-	P300	-	-	-	GTOUUP	GTIOC 0A_A	-	-	-	-	SSLB1 _B	-	-	-	-	-	-	-	-
C3	89	A1	73	51	TMS/SW DIO	-	P108	-	-	-	GTOULO	GTIOC 0B_A	-	-	CTS9 RTS9/ SS9	-	SSLB0 _B	-	-	-	-	-	-	-	-
A1	90	D4	74	52	CLKOUT /TDO/S WO	-	P109	-	-	-	GTOVUP	GTIOC 1A_A	-	CTX1	TXD9/ MOSI9 /SDA9	-	MOSIB _B	-	-	-	-	-	-	-	-
D3	91	B1	75	53	TDI	IRQ3	P110	-	-	-	GTOVLO	GTIOC 1B_A	-	CRX1	CTS2 RTS2/ SS2	RXD9/ MISO9 /SCL9	MISOB _B	-	-	-	-	-	-	-	VCOUT
D4	92	C2	76	54	-	IRQ4	P111	A05	A05	-	-	GTIOC 3A_A	-	-	SCK2	SCK9	RSPC KB_B	-	-	-	-	-	-	-	LCD_DATA 12_A
B2	93	D3	77	55	-	-	P112	A04	A04	-	-	GTIOC 3B_A	-	TXD2/ MOSI2 /SDA2	SCK1	-	SSLB0 _B	SSIBC K0_B	-	-	-	-	-	-	LCD_DATA 11_A
B1	94	C1	78	56	-	-	P113	A03	A03	-	-	GTIOC 2A	-	RXD2/ MISO2 /SCL2	-	-	SSLIR CK0/S SIFS0_B	-	-	-	-	-	-	-	LCD_DATA 10_A
C2	95	E4	79	57	-	-	P114	A02	A02	-	-	GTIOC 2B	-	-	-	-	SSIRX D0_B	-	-	-	-	-	-	-	LCD_DATA 09_A
C1	96	E3	80	58	-	-	P115	A01	A01	-	-	GTIOC 4A	-	-	-	-	SSITX D0_B	-	-	-	-	-	-	-	LCD_DATA 08_A
E3	97	D2	81	-	VCC	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
E4	98	D1	82	-	VSS	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
D2	99	F4	83	59	-	-	P608	A00/ BC0	A00/D QM1	-	-	GTIOC 4B	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 07_A
D1	100	E2	84	60	-	-	P609	CS1	CKE	-	-	GTIOC 5A	-	CTX1	-	-	-	-	-	-	-	-	-	-	LCD_DATA 06_A
F3	101	F3	85	61	-	-	P610	CS0	WE	-	-	GTIOC 5B	-	CRX1	-	-	-	-	-	-	-	-	-	-	LCD_DATA 05_A
E2	102	E1	86	-	CLKOUT /CACRE F	-	P611	-	SDCS	-	-	-	-	-	CTS7 RTS7/ SS7	-	-	-	-	-	-	-	-	-	-
E1	103	F2	87	-	-	-	P612	D08/ A08/ D08]	DQ08	-	-	-	-	-	SCK7	-	-	-	-	-	-	-	-	-	-
F4	104	F1	88	-	-	-	P613	D09/ A09/ D09]	DQ09	-	-	-	-	-	TXD7	-	-	-	-	-	-	-	-	-	-
F2	105	G3	89	-	-	-	P614	D10/ A10/ D10]	DQ10	-	-	-	-	-	RXD7	-	-	-	-	-	-	-	-	-	-
F1	106	-	-	-	-	-	P615	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 10_B
G1	107	-	-	-	-	-	PA08	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 09_B

Pin number					Power, System, Clock, Debug, CAC	Interrupt	I/O port	Extbus		Timers			Communication interfaces										Analog		HMI	
BGA176	LQFP176	LGA145	LQFP144	LQFP100				External bus	SDRAM	AGT	GPT	GPT	RTC	USBFS, CAN	SCI0,2,4,6,8 (30 MHz)	SCI1,3,5,7,9 (30 MHz)	IIC	SPI, QSPI	SSIE	ETHERC (MII) (25 MHz)	ETHERC (RMII) (50 MHz)	USBHS	SDHI	ADC12	DAC12, ACMPHS	CTSU
G4	108	-	-	-	-	-	PA09	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 08_B
G2	109	-	-	-	-	-	PA10	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 07_B
G3	110	G1	90	62	VCC	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
H3	111	G2	91	63	VSS	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
H1	112	H1	92	64	VCL	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
H2	113	-	-	-	-	-	PA01	-	-	-	-	SCK8	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 06_B
H4	114	-	-	-	-	-	PA00	-	-	-	-	TXD8	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 05_B
J4	115	-	-	-	-	-	P607	-	-	-	-	RXD8	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 04_B
J1	116	-	-	-	-	-	P606	-	-	-	RTC OUT	CTS8 RTS8/ SS8	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 03_B
J2	117	H2	93	-	-	-	P605	D11[A11/ D11]	DQ11	-	-	GTIOC 8A	-	-	-	-	-	-	-	-	-	-	-	-	-	-
J3	118	G4	94	-	-	-	P604	D12[A12/ D12]	DQ12	-	-	GTIOC 8B	-	-	-	-	-	-	-	-	-	-	-	-	-	-
K3	119	H3	95	-	-	-	P603	D13[A13/ D13]	DQ13	-	-	GTIOC 7A	-	-	CTS9 RTS9/ SS9	-	-	-	-	-	-	-	-	-	-	-
K1	120	J1	96	65	-	-	P602	EBC LK	SDCL K	-	-	GTIOC 7B	-	-	TXD9	-	-	-	-	-	-	-	-	-	-	LCD_DATA 04_A
K2	121	J2	97	66	-	-	P601	WR/ WR0	DQM0	-	-	GTIOC 6A	-	-	RXD9	-	-	-	-	-	-	-	-	-	-	LCD_DATA 03_A
L1	122	H4	98	67	CLKOUT /CACRE F	-	P600	RD	-	-	-	GTIOC 6B	-	-	SCK9	-	-	-	-	-	-	-	-	-	-	LCD_DATA 02_A
K4	123	K2	99	-	VCC	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
L4	124	K1	100	-	VSS	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
L2	125	J3	101	68	-	KR07	P107	D07[A07/ D07]	DQ07	AGTOA0	-	GTIOC 8A	-	-	CTS8 RTS8/ SS8	-	-	-	-	-	-	-	-	-	-	LCD_DATA 01_A
M1	126	K3	102	69	-	KR06	P106	D06[A06/ D06]	DQ06	AGTOB0	-	GTIOC 8B	-	-	SCK8	-	-	SSLA3 _A	-	-	-	-	-	-	-	LCD_DATA 00_A
L3	127	J4	103	70	-	IRQ0/ KR05	P105	D05[A05/ D05]	DQ05	-	GTETRGA	GTIOC 1A	-	-	TXD8/ MOSI8 /SDA8	-	-	SSLA2 _A	-	-	-	-	-	-	-	LCD_TCO N3_A
M2	128	L3	104	71	-	IRQ1/ KR04	P104	D04[A04/ D04]	DQ04	-	GTETRGB	GTIOC 1B	-	-	RXD8/ MISO8 /SCL8	-	-	SSLA1 _A	-	-	-	-	-	-	-	LCD_TCO N2_A
N1	129	L1	105	72	-	KR03	P103	D03[A03/ D03]	DQ03	-	GTOWUP	GTIOC 2A_A	-	CTX0	CTS0 RTS0/ SS0	-	-	SSLA0 _A	-	-	-	-	-	-	-	LCD_TCO N1_A
M3	130	M1	106	73	-	KR02	P102	D02[A02/ D02]	DQ02	AGTO0	GTOWLO	GTIOC 2B_A	-	CRX0	SCK0	-	-	RSPC KA_A	-	-	-	-	ADTRG 0	-	-	LCD_TCO N0_A
N2	131	M2	107	74	-	IRQ1/ KR01	P101	D01[A01/ D01]	DQ01	AGTEE0	GTETRGB	GTIOC 5A	-	-	TXD0/ MOSI0 /SDA0	CTS1 RTS1/ SS1	SDA1 _B	MOSIA _A	-	-	-	-	-	-	-	LCD_CLK_ A
P1	132	N1	108	75	-	IRQ2/ KR00	P100	D00[A00/ D00]	DQ00	AGTIO0	GTETRGA	GTIOC 5B	-	-	RXD0/ MISO0 /SCL0	SCK1 _B	SCLA1 _B	MISOA _A	-	-	-	-	-	-	-	LCD_EXT CLK_A
N3	133	L2	109	-	-	-	P800	D14[A14/ D14]	DQ14	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
R1	134	N2	110	-	-	-	P801	D15[A15/ D15]	DQ15	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
P2	135	-	-	-	-	-	P802	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 02_B
R2	136	-	-	-	-	-	P803	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 01_B
P3	137	-	-	-	-	-	P804	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_DATA 00_B
N4	138	N3	111	-	VCC	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
M4	139	M3	112	-	VSS	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
R3	140	K4	113	76	-	-	P500	-	-	AGTOA0	GTIU	GTIOC 11A	-	USB_ VBUS EN	-	-	QSPC LK	-	-	-	-	SD1 CLK_ A	AN016	IVREF0	-	-
P4	141	M4	114	77	-	IRQ11	P501	-	-	AGTOB0	GTIV	GTIOC 11B	-	USB_ OVR CUR A	TXD5/ MOSI5 /SDA5	-	QSSL	-	-	-	SD1 CMD _A	AN116	IVREF1	-	-	
R4	142	L4	115	78	-	IRQ12	P502	-	-	-	GTIW	GTIOC 12A	-	USB_ OVR CUR B	RXD5/ MISO5 /SCL5	-	QIO0	-	-	-	SD1 DAT0 _A	AN017	IVCMP0	-	-	
N5	143	K5	116	79	-	-	P503	-	-	GTETRGC	GTIOC 12B	-	-	USB_ EXIC EN	CTS6 RTS6/ SS6	SCK5	-	QIO1	-	-	-	SD1 DAT1 _A	AN117	-	-	-
P5	144	L5	117	80	-	-	P504	ALE	-	GTETRGD	GTIOC 13A	-	-	USB_ ID	SCK6 RTS5/ SS5	CTS5 RTS5/ SS5	-	QIO2	-	-	-	SD1 DAT2 _A	AN018	-	-	-
P6	145	K6	118	-	-	IRQ14	P505	-	-	-	GTIOC 13B	-	-	RXD6/ MISO6 /SCL6	-	-	QIO3	-	-	-	-	SD1 DAT3 _A	AN118	-	-	-

Pin number						Power, System, Clock, Debug, CAC	Interrupt	I/O port	Extbus		Timers				Communication interfaces										Analog		HMI	
BGA176	LQFP176	LG145	LQFP144	LQFP100					External bus	SDRAM	AGT	GPT	GPT	RTC	USBFS, CAN	SCI, 2, 4, 6, 8 (30 MHz)	SCI, 3, 5, 7, 9 (30 MHz)	IIC	SPI, QSPI	SSIE	ETHERC (MI) (25 MHz)	ETHERC (RMII) (50 MHz)	USBHS	SDHI	ADC12	DAC12, ACMPHS	CTSU	GLDC, PDC
R5	146	L6	119	-	-	-	IRQ15	P506	-	-	-	-	-	-	-	TXD6/ MOSI6 /SDA6	-	-	-	-	-	-	-	SD1 CD_ A	AN019	-	-	-
N6	147	-	-	-	-	-	-	P507	-	-	-	-	-	-	-	-	CTS5_ RTS5/ SS5	-	-	-	-	-	-	SD1 WP_ A	AN119	-	-	-
R6	148	N4	120	81	-	-	-	P508	-	-	-	-	-	-	-	SCK6	SCK5	-	-	-	-	-	-	-	AN020	-	-	-
M7	149	N5	121	82	VCC	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
N7	150	M5	122	83	VSS	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
P7	151	M6	123	84	-	-	IRQ13	P015	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	AN006/ AN106	DA1/ IVCMP1	-	-
R7	152	N6	124	85	-	-	-	P014	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	AN005/ AN105	DA0/ IVREF3	-	-
P8	153	M7	125	86	VREFL	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
R8	154	N7	126	87	VREFH	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
N8	155	L7	127	88	AVCC0	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
N9	156	L8	128	89	AVSS0	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
P9	157	M8	129	90	VREFL0	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
R9	158	N8	130	91	VREFH0	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
M8	159	-	-	-	-	-	IRQ14 -DS	P010	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	AN103	-	-	-
M9	160	M9	131	-	-	-	IRQ13 -DS	P009	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	AN004	-	-	-
P10	161	N9	132	92	-	-	IRQ12 -DS	P008	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	AN003	-	-	-
M6	162	K7	133	93	-	-	-	P007	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	PGAVS S100/A N107	-	-	-
N10	163	L9	134	94	-	-	IRQ11 -DS	P006	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	AN102	IVCMP2	-	-
R10	164	K8	135	95	-	-	IRQ10 -DS	P005	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	AN101	IVCMP2	-	-
P11	165	K9	136	96	-	-	IRQ9 -DS	P004	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	AN100	IVCMP2	-	-
M5	166	K10	137	97	-	-	-	P003	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	PGAVS S000/A N007	-	-	-
R11	167	M10	138	98	-	-	IRQ8 -DS	P002	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	AN002	IVCMP2	-	-
N11	168	N10	139	99	-	-	IRQ7 -DS	P001	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	AN001	IVCMP2	-	-
R12	169	L10	140	100	-	-	IRQ6 -DS	P000	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	AN000	IVCMP2	-	-
M10	170	N11	141	-	VSS	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
M11	171	N12	142	-	VCC	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
P12	172	-	-	-	-	-	-	P806	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	LCD_EXT CLK_B
R13	173	-	-	-	-	-	-	P805	-	-	-	-	-	-	-	-	TXD5	-	-	-	-	-	-	-	-	-	-	LCD_DATA 17_B
N12	174	-	-	-	-	-	-	P513	-	-	-	-	-	-	-	-	RXD5	-	-	-	-	-	-	-	-	-	-	LCD_DATA 16_B
R14	175	M11	143	-	-	-	IRQ14	P512	-	-	-	GTIOC 0A	CTX1	TXD4/ MOSI4 /SDA4	-	SCL2	-	-	-	-	-	-	-	-	-	-	-	VSYNC
P13	176	M12	144	-	-	-	IRQ15	P511	-	-	-	GTIOC 0B	CRX1	RXD4/ MISO4 /SCL4	-	SDA2	-	-	-	-	-	-	-	-	-	-	-	PCKO

Note: Some pin names have the added suffix of _A, _B, and _C. When assigning the GPT, IIC, SPI, SSIE, ETHERC (RMII), SDHI, and GLDC functionality, select the functional pins with the same suffix.

2. Electrical Characteristics

Unless otherwise specified, the electrical characteristics of the MCU are defined under the following conditions:

$VCC = AVCC0 = VCC_USB = VBATT = 2.7$ to 3.6 V, $2.7 \leq VREFH0/VREFH \leq AVCC0$, $VCC_USBHS = AVCC_USBHS = 3.0$ to 3.6 V, $VSS = AVSS0 = VREFL0/VREFL = VSS_USB = VSS1_USBHS = VSS2_USBHS = PVSS_USBHS = AVSS_USBHS = 0$ V, $T_a = T_{opr}$

Figure 2.1 shows the timing conditions.

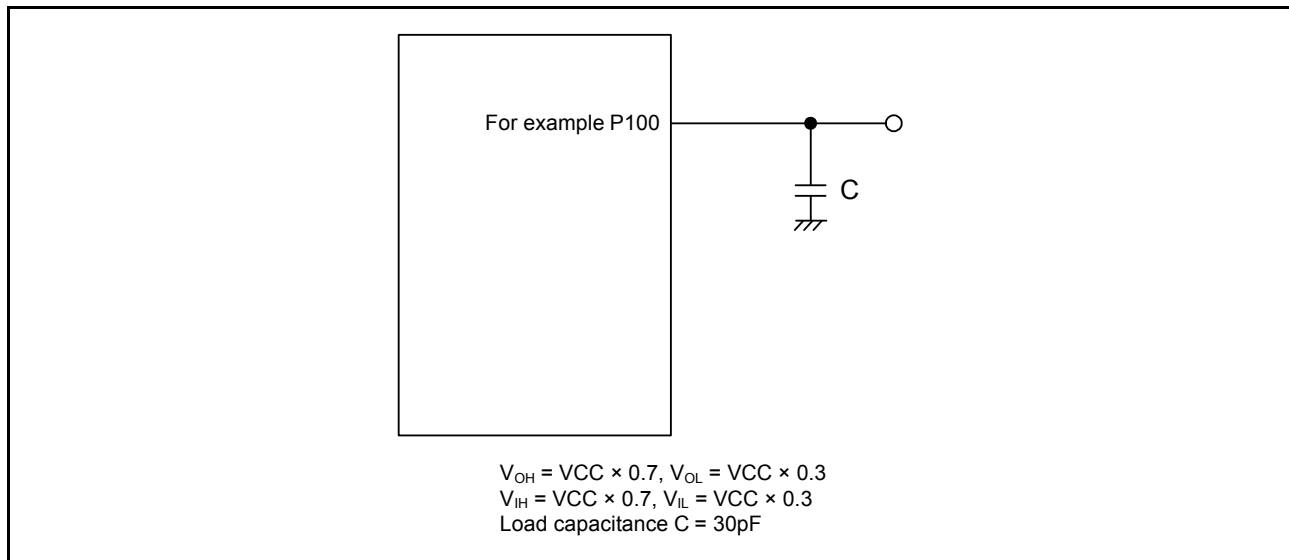


Figure 2.1 Input or output timing measurement conditions

The measurement conditions of timing specification in each peripherals are recommended for the best peripheral operation, however make sure to adjust driving abilities of each pins to meet your conditions.

2.1 Absolute Maximum Ratings

Table 2.1 Absolute maximum ratings

Item	Symbol	Value	Unit
Power supply voltage	VCC , VCC_USB *2	-0.3 to +4.0	V
VBATT power supply voltage	VBATT	-0.3 to +4.0	V
Input voltage (except for 5V-tolerant ports*1)	V_{in}	-0.3 to $VCC + 0.3$	V
Input voltage (5V-tolerant ports*1)	V_{in}	-0.3 to $+VCC + 4.0$ (max 5.8)	V
Reference power supply voltage	$VREFH/VREFH0$	-0.3 to $VCC + 0.3$	V
Analog power supply voltage	$AVCC0$ *2	-0.3 to +4.0	V
USBHS power supply voltage	VCC_USBHS	-0.3 to +4.0	V
USBHS analog power supply voltage	$AVCC_USBHS$	-0.3 to +4.0	V
Analog input voltage	V_{AN}	-0.3 to $AVCC0 + 0.3$	V
Operating temperature*3,*4,*5	T_{opr}	-40 to +85 -40 to +105	°C
Storage temperature	T_{stg}	-55 to +125	°C

Caution: Permanent damage to the MCU might result if absolute maximum ratings are exceeded.

Note 1. Ports P205, P206, P400, P401, P407 to P415, P511, P512, P708 to P713, and PB01 are 5V-tolerant.

Note 2. Connect $AVCC0$ and VCC_USB to VCC .

Note 3. See section 2.2.1, T_j/T_a Definition.

Note 4. Contact a Renesas Electronics sales office for information on derating operation when $T_a = +85^\circ\text{C}$ to $+105^\circ\text{C}$. Derating is the systematic reduction of load for improved reliability.

Note 5. The upper limit of operating temperature is 85°C or 105°C , depending on the product. For details, see section 1.3, Part Numbering.

Table 2.7 Operating and standby current (2 of 2)

Item			Symbol	Min	Typ	Max	Unit	Test conditions
USB operating current	Low speed	USB	$I_{CCUSBLS}$	-	3.5	6.5	mA	VCC_USB
		USBHS		-	10.5	13.5	mA	VCC_USBHS = AVCC_USBHS (PHYSET.HSEB = 0)
		USBHS		-	2.8	3.6	mA	VCC_USBHS = AVCC_USBHS (PHYSET.HSEB = 1)
	Full speed	USB	$I_{CCUSBFS}$	-	4.0	10.0	mA	VCC_USB
		USBHS		-	14	22	mA	VCC_USBHS = AVCC_USBHS (PHYSET.HSEB = 0)
		USBHS		-	6.5	13.0	mA	VCC_USBHS = AVCC_USBHS (PHYSET.HSEB = 1)
	High speed	USBHS	$I_{CCUSBHS}$	-	50	65	mA	VCC_USBHS = AVCC_USBHS
	Standby mode (direct power down)	USBHS	$I_{CCUSBSBY}$	-	0.5	4.5	μA	VCC_USBHS = AVCC_USBHS

Note 1. Supply current values are with all output pins unloaded and all input pull-up MOS transistors in the off state.

Note 2. Measured with clocks supplied to the peripheral functions. This does not include the BGO operation.

Note 3. ICC depends on f (ICLK) as follows. (ICLK:PCLKA:PCLKB:PCLKC:PCLKD:BCK:EBCLK = 2:2:1:1:2:1:1)

ICC Max. = $0.84 \times f + 37$ (max. operation in High-speed mode)

ICC Typ. = $0.09 \times f + 3.7$ (normal operation in High-speed mode)

ICC Typ. = $0.6 \times f + 1.8$ (Low-speed mode 1)

ICC Max. = $0.08 \times f + 37$ (Sleep mode).

Note 4. This does not include the BGO operation.

Note 5. Supply of the clock signal to peripherals is stopped in this state. This does not include the BGO operation.

Note 6. FCLK, BCLK, PCLKA, PCLKB, PCLKC, and PCLKD are set to divided by 64 (3.75 MHz).

Note 7. When using ETHERC, GLCDC, DRW, and JPEG, PCLKA frequency is such that PCLKA = ICLK.

Note 8. When the MCU is in Software Standby mode or the MSTPCRD.MSTPD16 (ADC120 module stop bit) and MSTPCRD.MSTPD15 (ADC121 module stop bit) are in the module stop state.

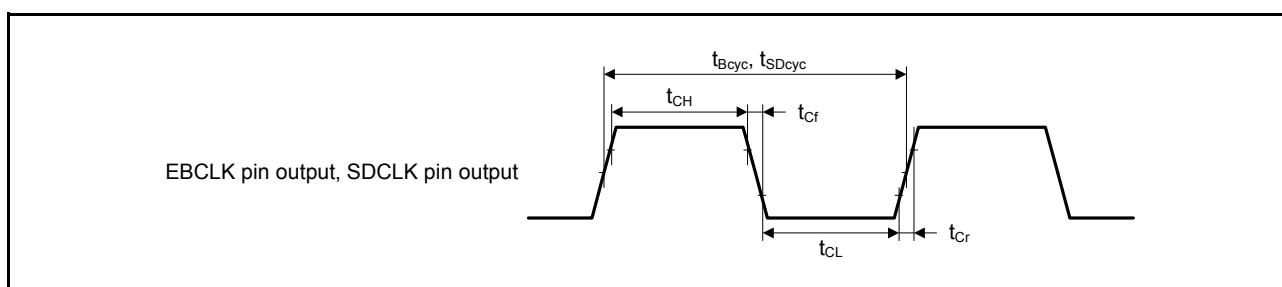


Figure 2.3 EBCLK and SDCLK output timing

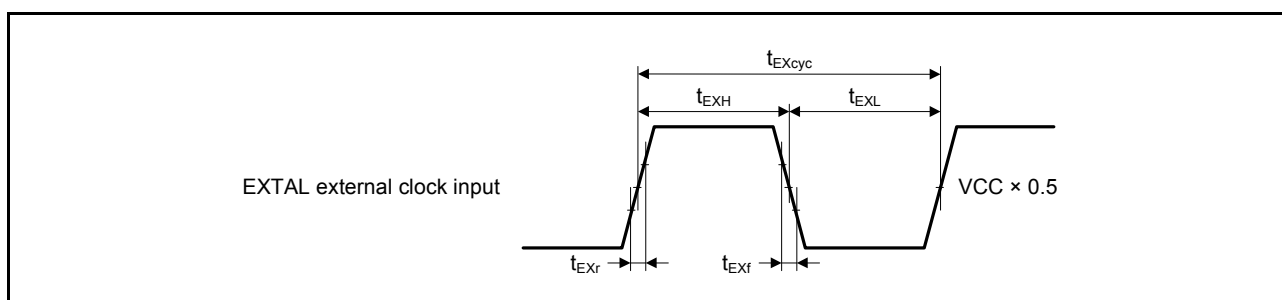


Figure 2.4 EXTERNAL external clock input timing

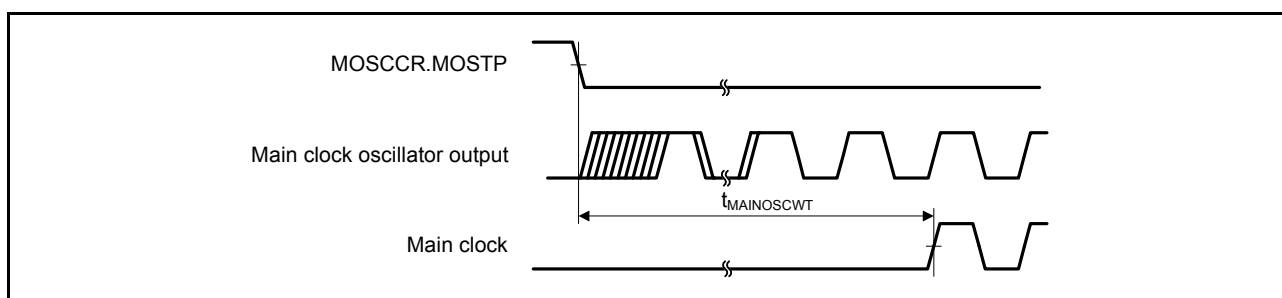


Figure 2.5 Main clock oscillation start timing

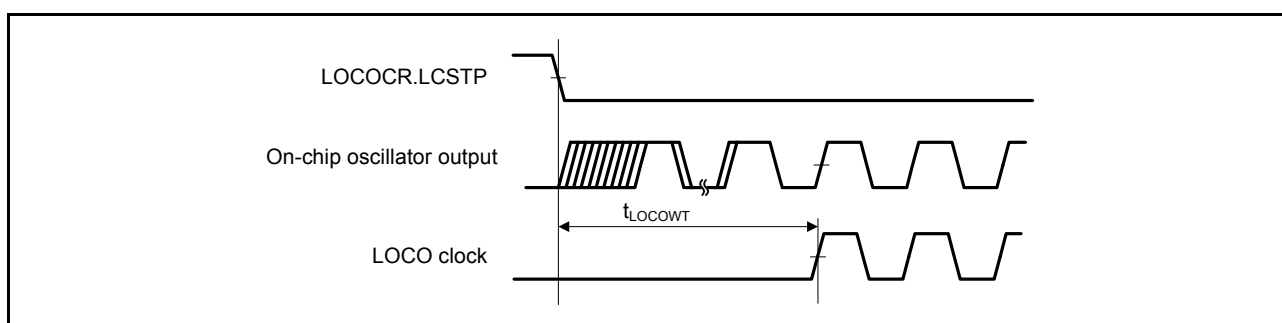


Figure 2.6 LOCO clock oscillation start timing

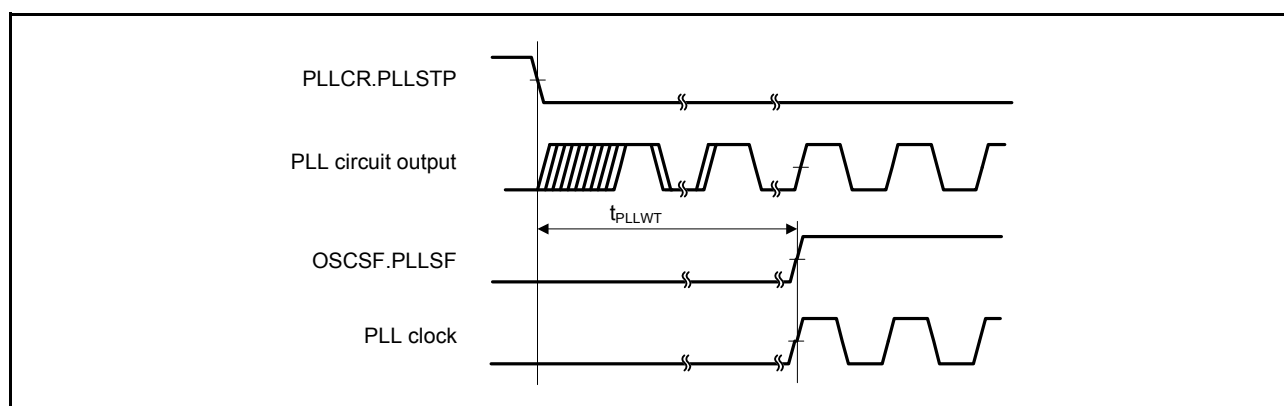


Figure 2.7 PLL clock oscillation start timing

Note: Only operate the PLL is operated after main clock oscillation has stabilized.

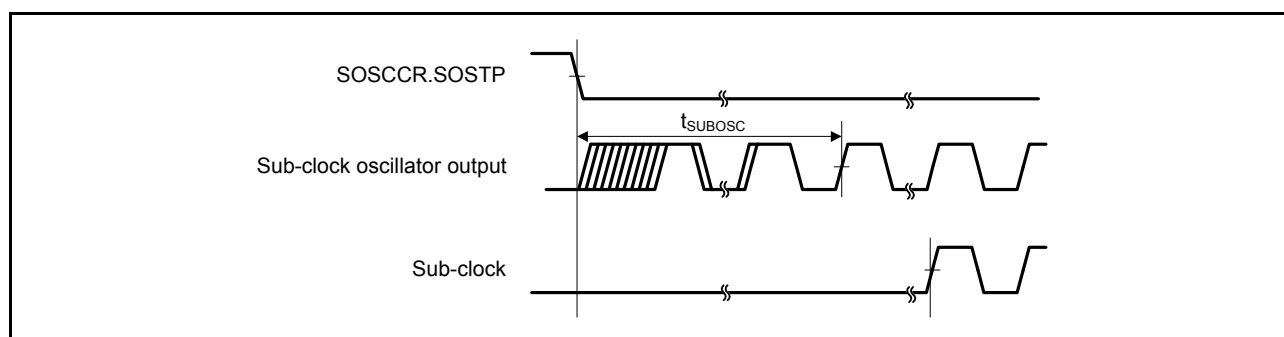


Figure 2.8 Sub-clock oscillation start timing

2.3.3 Reset Timing

Table 2.15 Reset timing

Item		Symbol	Min	Typ	Max	Unit	Test conditions
RES pulse width	Power-on	t_{RESWP}	1	-	-	ms	Figure 2.9
	Deep Software Standby mode	t_{RESWD}	0.6	-	-	ms	Figure 2.10
	Software Standby mode, Subosc-speed mode	t_{RESWS}	0.3	-	-	ms	
	All other	t_{RESW}	200	-	-	μ s	
Wait time after RES cancellation		t_{RESWT}	-	29	33	μ s	Figure 2.9
Wait time after internal reset cancellation (IWDt reset, WDT reset, software reset, SRAM parity error reset, SRAM ECC error reset, bus master MPU error reset, bus slave MPU error reset, stack pointer error reset)		t_{RESW2}	-	320	408	μ s	-

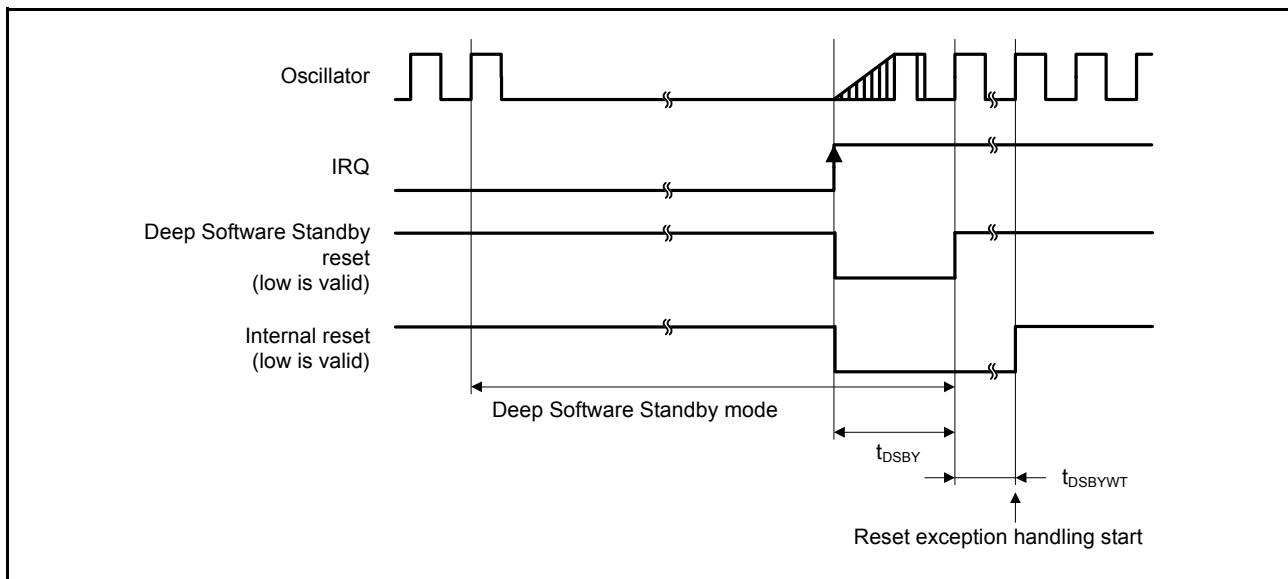


Figure 2.12 Deep Software Standby mode cancellation timing

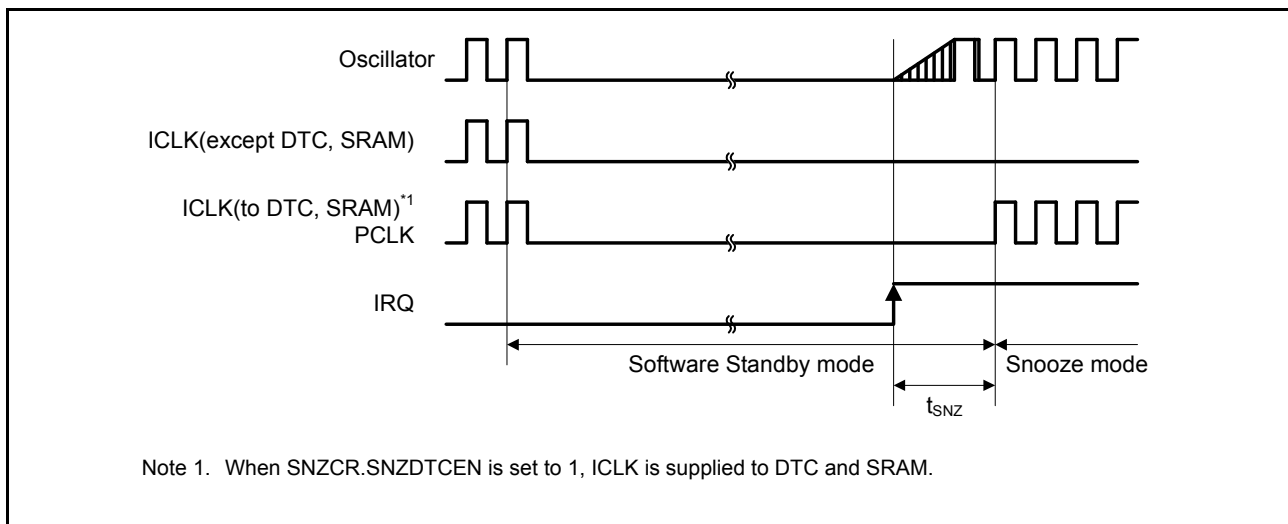


Figure 2.13 Recovery timing from Software Standby mode to Snooze mode

2.3.5 NMI and IRQ Noise Filter

Table 2.17 NMI and IRQ noise filter

Item	Symbol	Min	Typ	Max	Unit	Test conditions	
NMI pulse width	t_{NMIW}	200	-	-	ns	NMI digital filter disabled	$t_{Pcyc} \times 2 \leq 200$ ns
		$t_{Pcyc} \times 2^{*1}$	-	-			$t_{Pcyc} \times 2 > 200$ ns
		200	-	-		NMI digital filter enabled	$t_{NMICK} \times 3 \leq 200$ ns
		$t_{NMICK} \times 3.5^{*2}$	-	-			$t_{NMICK} \times 3 > 200$ ns
IRQ pulse width	t_{IRQW}	200	-	-	ns	IRQ digital filter disabled	$t_{Pcyc} \times 2 \leq 200$ ns
		$t_{Pcyc} \times 2^{*1}$	-	-			$t_{Pcyc} \times 2 > 200$ ns
		200	-	-		IRQ digital filter enabled	$t_{IRQCK} \times 3 \leq 200$ ns
		$t_{IRQCK} \times 3.5^{*3}$	-	-			$t_{IRQCK} \times 3 > 200$ ns

Note: 200 ns minimum in Software Standby mode.

Note 1. t_{Pcyc} indicates the PCLKB cycle.

Note 2. t_{NMICK} indicates the cycle of the NMI digital filter sampling clock.

Note 3. t_{IRQCK} indicates the cycle of the IRQi digital filter sampling clock.

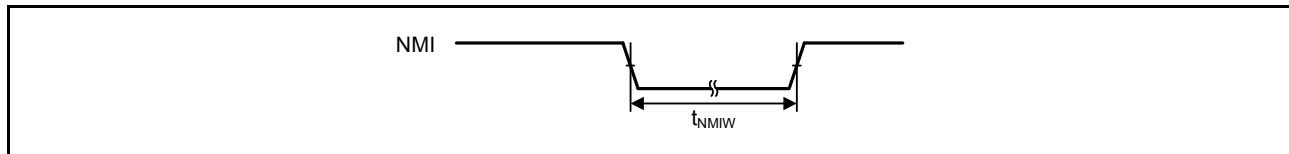


Figure 2.14 NMI interrupt input timing

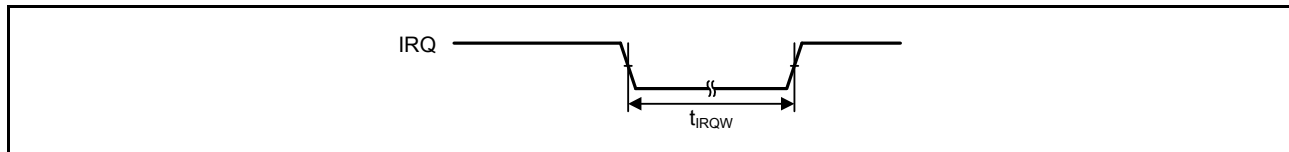


Figure 2.15 IRQ interrupt input timing

2.3.6 Bus Timing

Table 2.18 Bus timing (1 of 2)

Condition 1: When using the CS area controller (CSC).

BCLK = 8 to 120 MHz, EBCLK = 8 to 60 MHz

VCC = AVCC0 = VCC_USB = VBATT = 2.7 to 3.6 V, VREFH/VREFH0 = 2.7 V to AVCC0,

VCC_USBHS = AVCC_USBHS = 3.0 to 3.6 V

Output load conditions: VOH = VCC × 0.5, VOL = VCC × 0.5, C = 30 pF

EBCLK: High drive output is selected in the port drive capability bit in the PmnPFS register.

Others: Middle drive output is selected in the port drive capability bit in the PmnPFS register.

Condition 2: When using the SDRAM area controller (SDRAMC).

BCLK = SDCLK = 8 to 120 MHz

VCC = AVCC0 = VCC_USB = VBATT = 3.0 to 3.6 V, VREFH/VREFH0 = 3.0 V to AVCC0,

VCC_USBHS = AVCC_USBHS = 3.0 to 3.6 V

Output load conditions: VOH = VCC × 0.5, VOL = VCC × 0.5, C = 15 pF

High drive output is selected in the port drive capability bit in the PmnPFS register.

Condition 3: When using the SDRAM area controller (SDRAMC) and CS area controller (CSC) simultaneously.

BCLK = SDCLK = 8 to 60 MHz

VCC = AVCC0 = VCC_USB = VBATT = 3.0 to 3.6 V, VREFH/VREFH0 = 3.0 V to AVCC0,

VCC_USBHS = AVCC_USBHS = 3.0 to 3.6 V

Output load conditions: VOH = VCC × 0.5, VOL = VCC × 0.5, C = 15 pF

High drive output is selected in the port drive capability bit in the PmnPFS register.

Item	Symbol	Min	Max	Unit	Test conditions
Address delay	t_{AD}	-	12.5	ns	Figure 2.18 to Figure 2.21
Byte control delay	t_{BCD}	-	12.5	ns	
CS delay	t_{CSD}	-	12.5	ns	
ALE delay time	t_{ALED}	-	12.5	ns	
RD delay	t_{RSD}	-	12.5	ns	
Read data setup time	t_{RDS}	12.5	-	ns	
Read data hold time	t_{RDH}	0	-	ns	
WR/WRn delay	t_{WRD}	-	12.5	ns	Figure 2.22
Write data delay	t_{WDD}	-	12.5	ns	
Write data hold time	t_{WDH}	0	-	ns	
WAIT setup time	t_{WTS}	12.5	-	ns	Figure 2.22
WAIT hold time	t_{WTH}	0	-	ns	

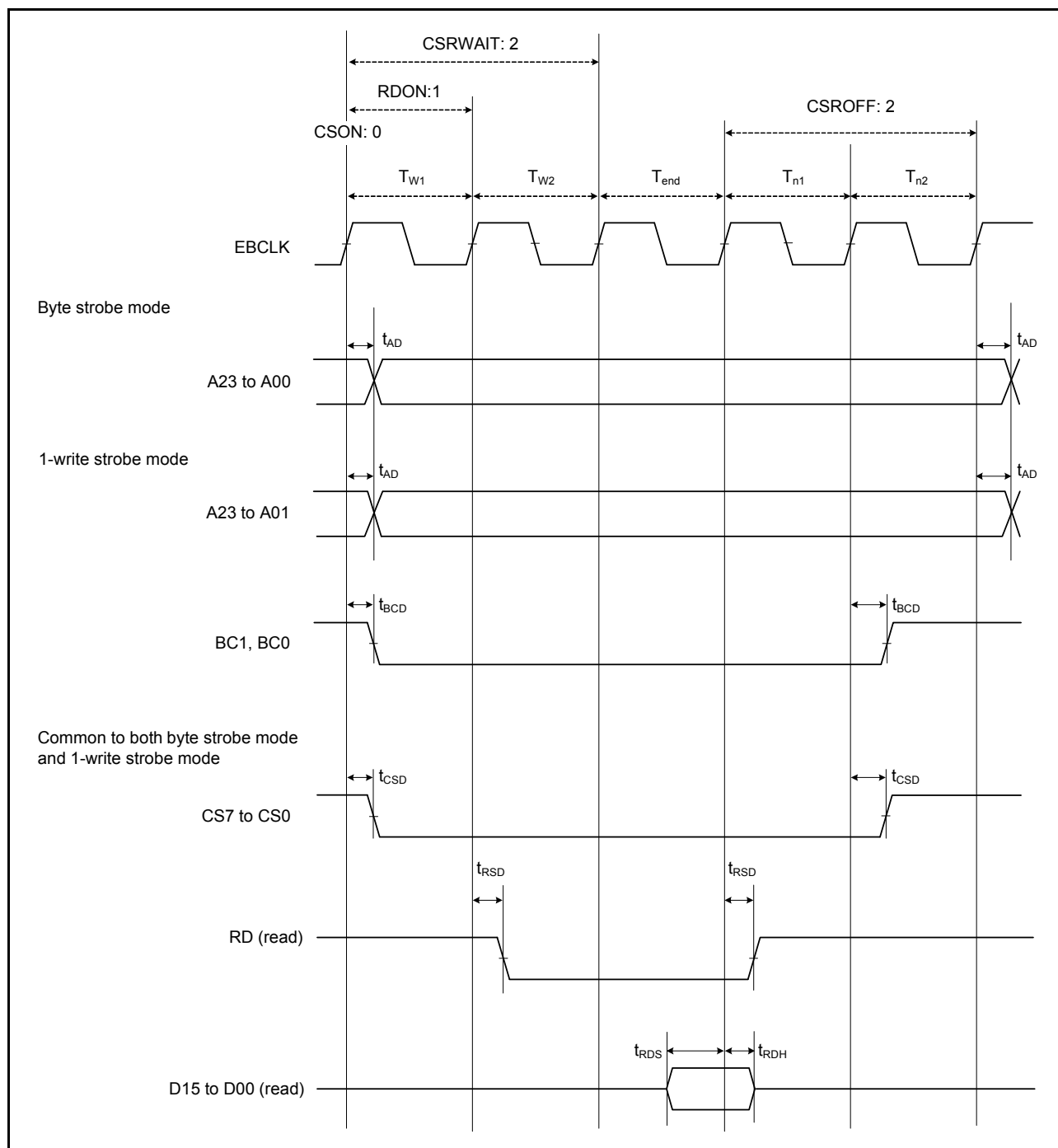


Figure 2.18 External bus timing for normal read cycle with bus clock synchronized

Note 1. t_{PBcyc} : PCLKB cycle.

Note 2. t_{cac} : CAC count clock source cycle.

2.3.10 SCI Timing

Table 2.22 SCI timing (1)

Conditions: High drive output is selected in the port drive capability bit in the PmnPFS register for the following pins: SCK0 to SCK9. For other pins, middle drive output is selected in the port drive capability bit in the PmnPFS register.

Item			Symbol	Min	Max	Unit*1	Test conditions
SCI	Input clock cycle	Asynchronous	t_{Scyc}	4	-	t_{Pcyc}	Figure 2.39
		Clock synchronous		6	-		
	Input clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Input clock rise time		t_{SCKr}	-	5	ns	
	Input clock fall time		t_{SCKf}	-	5	ns	
	Output clock cycle	Asynchronous	t_{Scyc}	6	-	t_{Pcyc}	
		Clock synchronous		4	-		
	Output clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Output clock rise time		t_{SCKr}	-	5	ns	
	Output clock fall time		t_{SCKf}	-	5	ns	
	Transmit data delay	Clock synchronous	t_{TXD}	-	25	ns	Figure 2.40
	Receive data setup time	Clock synchronous	t_{RXS}	15	-	ns	
	Receive data hold time	Clock synchronous	t_{RXH}	5	-	ns	

Note 1. t_{Pcyc} : PCLKA cycle.

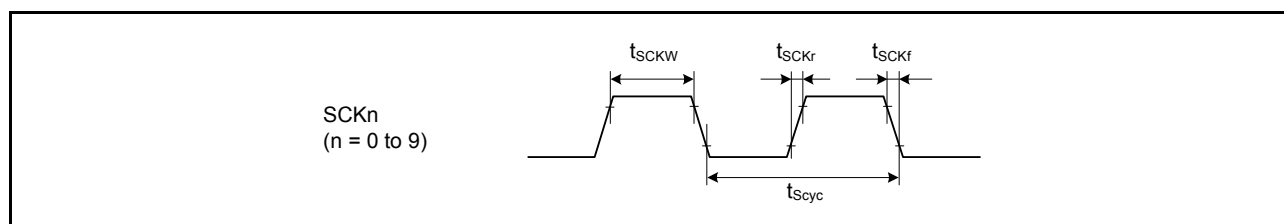


Figure 2.39 SCK clock input/output timing

Table 2.27 IIC timing (1) (2 of 2)

(1) Conditions: Middle drive output is selected in the port drive capability bit in the PmnPFS register for the following pins: SDA0_B, SCL0_B, SDA1_A, SCL1_A, SDA1_B, SCL1_B.

(2) The following pins do not require setting: SCL0_A, SDA0_A, SCL2, SDA2.

(3) Use pins that have a letter appended to their names, for instance “_A” or “_B”, to indicate group membership. For the IIC interface, the AC portion of the electrical characteristics is measured for each group.

Item		Symbol	Min*1	Max	Unit	Test conditions*3
IIC (Fast mode)	SCL input cycle time	t _{SCL}	6 (12) × t _{IICcyc} + 600	-	ns	Figure 2.56
	SCL input high pulse width	t _{SCLH}	3 (6) × t _{IICcyc} + 300	-	ns	
	SCL input low pulse width	t _{SCLL}	3 (6) × t _{IICcyc} + 300	-	ns	
	SCL, SDA input rise time	t _{Sr}	20 × (external pullup voltage/5.5V)*2	300	ns	
	SCL, SDA input fall time	t _{Sf}	20 × (external pullup voltage/5.5V)*2	300	ns	
	SCL, SDA input spike pulse removal time	t _{SP}	0	1 (4) × t _{IICcyc}	ns	
	SDA input bus free time when wakeup function is disabled	t _{BUF}	3 (6) × t _{IICcyc} + 300	-	ns	
	SDA input bus free time when wakeup function is enabled	t _{BUF}	3 (6) × t _{IICcyc} + 4 × t _{Pcyc} + 300	-	ns	
	START condition input hold time when wakeup function is disabled	t _{STAH}	t _{IICcyc} + 300	-	ns	
	START condition input hold time when wakeup function is enabled	t _{STAH}	1 (5) × t _{IICcyc} + t _{Pcyc} + 300	-	ns	
	Repeated START condition input setup time	t _{STAS}	300	-	ns	
	STOP condition input setup time	t _{STOS}	300	-	ns	
	Data input setup time	t _{SDAS}	t _{IICcyc} + 50	-	ns	
	Data input hold time	t _{SDAH}	0	-	ns	
SCL, SDA capacitive load		C _b	-	400	pF	

Note: t_{IICcyc} : IIC internal reference clock (IIC ϕ) cycle, t_{Pcyc} : PCLKB cycle.

Note 1. Values in parentheses apply when ICMR3.NF[1:0] is set to 11b while the digital filter is enabled with ICFER.NFE set to 1.

Note 2. Only supported for SCL0_A, SDA0_A, SCL2, and SDA2.

Note 3. Must use pins that have a letter (“_A”, “_B”) to indicate group membership appended to their name as groups. For the IIC interface, the AC portion of the electrical characteristics is measured for each group.

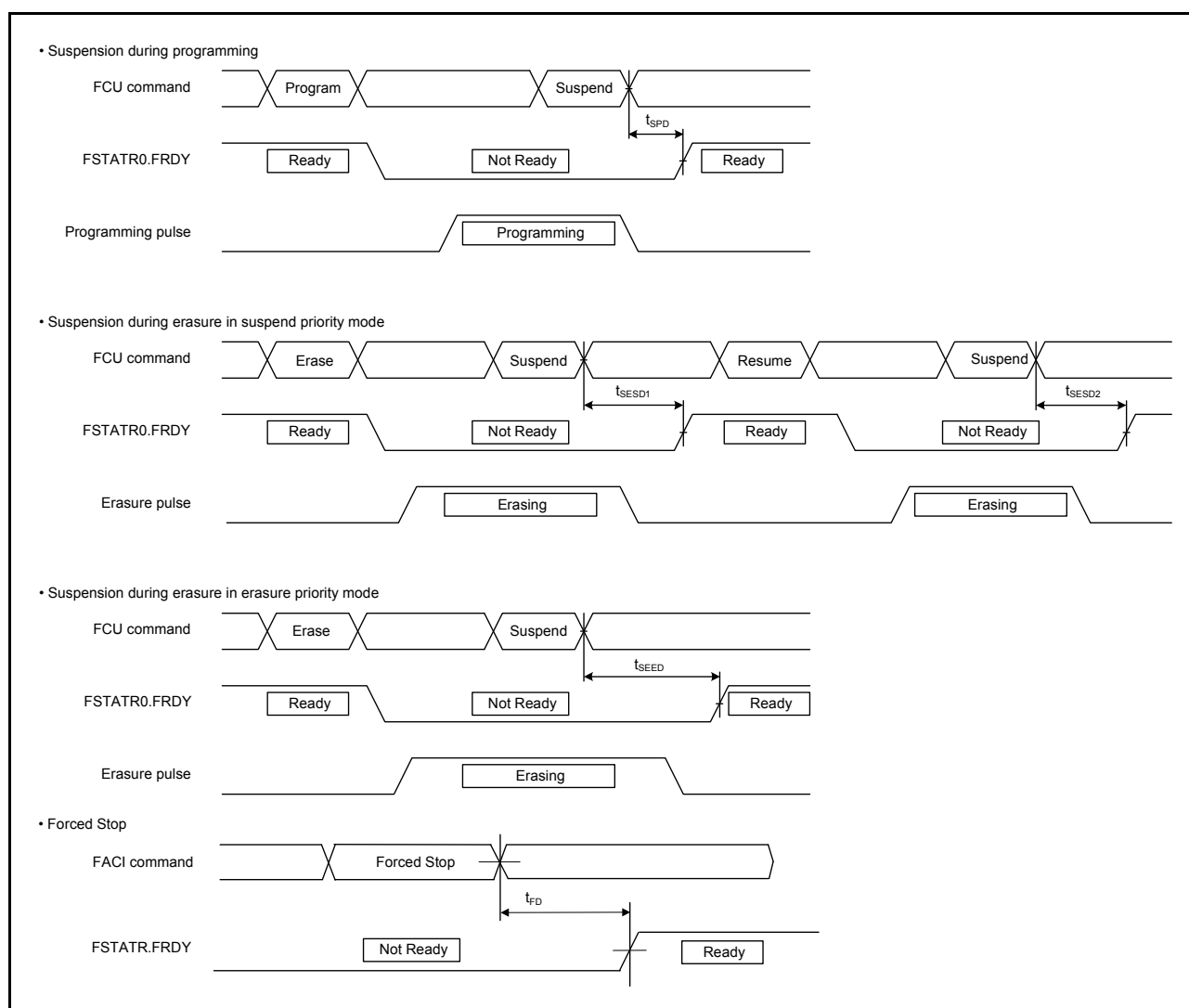


Figure 2.98 Suspension and forced stop timing for flash memory programming and erasure

2.14.2 Data Flash Memory Characteristics

Table 2.54 Data flash memory characteristics (1 of 2)

Conditions: Program or erase: FCLK = 4 to 60 MHz

Read: FCLK ≤ 60 MHz

Item		Symbol	FCLK = 4 MHz			20 MHz ≤ FCLK ≤ 60 MHz			Unit	Test conditions
			Min	Typ	Max	Min	Typ	Max		
Programming time	4-byte	t_{DP4}	-	0.46	3.8	-	0.21	1.7	ms	
	8-byte	t_{DP8}	-	0.48	4.0	-	0.22	1.8		
	16-byte	t_{DP16}	-	0.53	4.5	-	0.24	2.0		
Erasure time	64-byte	t_{DE64}	-	4.03	18	-	2.24	10	ms	
	128-byte	t_{DE128}	-	6.2	27	-	3.4	15		
	256-byte	t_{DE256}	-	11.6	50	-	6.4	28		
Blank check time	4-byte	t_{DBC4}	-	-	84	-	-	30	μs	
Reprogramming/erasure cycle*1		N_{DPEC}	125000*2	-	-	125000*2	-	-	-	

2.17 Serial Wire Debug (SWD)

Table 2.57 SWD

Item	Symbol	Min	Typ	Max	Unit	Test conditions
SWCLK clock cycle time	t_{SWCLKcyc}	40	-	-	ns	Figure 2.104
SWCLK clock high pulse width	t_{SWCKH}	15	-	-	ns	
SWCLK clock low pulse width	t_{SWCKL}	15	-	-	ns	
SWCLK clock rise time	t_{SWCKr}	-	-	5	ns	
SWCLK clock fall time	t_{SWCKf}	-	-	5	ns	
SWDIO setup time	t_{SWDS}	8	-	-	ns	Figure 2.105
SWDIO hold time	t_{SWDH}	8	-	-	ns	
SWDIO data delay time	t_{SWDD}	2	-	28	ns	

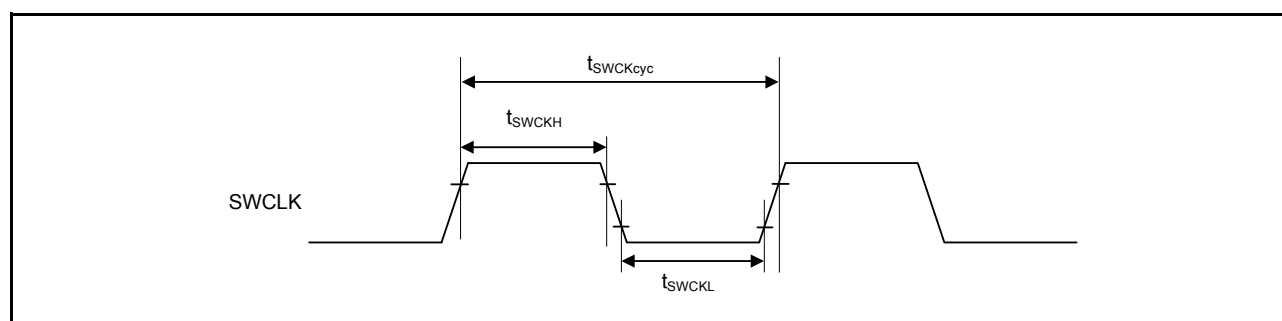


Figure 2.104 SWD SWCLK timing



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